

# **Automotive MOSFET**

# **OptiMOS™-5 Power-Transistor**







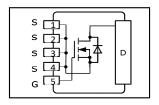
#### **Features**

- OptiMOS<sup>™</sup> power MOSFET for automotive applications
- N-channel Enhancement mode Normal Level
- Extended qualification beyond AEC-Q101
- Enhanced electrical testing
- Robust design
- MSL3 up to 260°C peak reflow
- 175°C operating temperature
- Green product (RoHS compliant)
- 100% Avalanche tested



General automotive applications.





**Product Summary** 

$V_{\mathrm{DS}}$	80	٧
R <sub>DS(on)</sub>	2.6	mΩ
I <sub>D</sub> (chip limited)	180	Α

Туре	Package	Marking
IAUA180N08S5N026	PG-HSOF-5-4	5N08026

# IAUA180N08S5N026



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# **Maximum ratings**

at Tj=25 °C, unless otherwise specified

Parameter	Symbol	Conditions	Value	Unit
Continuous drain current	I <sub>D</sub>	V <sub>GS</sub> =10 V, Chip limitation <sup>1)</sup>	180	A
		V <sub>GS</sub> =10V, DC current	180	
		$T_a$ =85 °C, $V_{GS}$ =10 V, $R_{thJA}$ on 2s2p <sup>2,3)</sup>	25	
Pulsed drain current <sup>2)</sup>	/ <sub>D,pulse</sub>	T <sub>C</sub> =25 °C, t <sub>p</sub> = 100 μs	546	1
Avalanche energy, single pulse <sup>2)</sup>	E AS	/ <sub>D</sub> =90 A	235	mJ
Avalanche current, single pulse	I AS	-	180	А
Gate source voltage	V <sub>GS</sub>	-	±20	V
Power dissipation	P <sub>tot</sub>	T <sub>C</sub> =25 °C	179	W
Operating and storage temperature	$T_{\rm j}, T_{\rm stg}$	-	-55 +175	°C
IEC climatic category; DIN IEC 68-1	-	-	55/175/56	

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# Thermal characteristics<sup>2)</sup>

Parameter	Symbol	Conditions	Values			Unit
			min.	typ.	max.	
Thermal resistance, junction - case	R thJC	-	-	-	0.84	K/W
Thermal resistance, junction - ambient <sup>3)</sup>	R <sub>thJA</sub>	-	-	22.9	-	

# **Electrical characteristics**

at Tj=25 °C, unless otherwise specified

Parameter	Symbol	Symbol Conditions		Values		
			min.	typ.	max.	
Static characteristics						
Drain-source breakdown voltage	$V_{(BR)DSS}$	$V_{\rm GS}$ =0 V, $I_{\rm D}$ =1 mA	80	-	-	V
Gate threshold voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_{D} = 100 \mu\text{A}$	2.2	3	3.8	
Zero gate voltage drain current	I <sub>DSS</sub>	$V_{\rm DS}$ =80 V, $V_{\rm GS}$ =0 V, $T_{\rm j}$ =25 °C	-	0.1	1	μΑ
		$V_{DS}$ =80 V, $V_{GS}$ =0 V, $T_{j}$ =100 °C <sup>2)</sup>	-	1	100	
Gate-source leakage current	I <sub>GSS</sub>	V <sub>GS</sub> =20 V, V <sub>DS</sub> =0 V	-	-	100	nA
Drain-source on-state resistance	R <sub>DS(on)</sub>	$V_{GS}$ =6 V, $I_{D}$ =45 A		3.0	3.6	mΩ
		$V_{GS}$ =10 V, $I_{D}$ =90 A	-	2.1	2.6	
Gate resistance <sup>2)</sup>	R <sub>G</sub>	-	-	1.3	-	Ω

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Parameter	Symbol Conditions		Values			Unit
			min.	typ.	max.	
Dynamic characteristics <sup>2)</sup>						
Input capacitance	C iss		-	4600	5980	pF
Output capacitance	C oss	$V_{GS}$ =0 V, $V_{DS}$ =40 V, $f$ =1 MHz	-	803	1045	
Reverse transfer capacitance	C <sub>rss</sub>	1	-	34	51	1
Turn-on delay time	t d(on)		-	11	-	ns
Rise time	t <sub>r</sub>	$V_{\rm DD}$ =40 V, $V_{\rm GS}$ =10 V,	-	7	-	1
Turn-off delay time	t d(off)	$I_{D}$ =90 A, $R_{G}$ =3.5 Ω	-	21	-	
Fall time	t f	7	-	16	-	1
Gate to drain charge  Gate charge total	Q gs Q gd	V <sub>DD</sub> =40 V, I <sub>D</sub> =90 A, V <sub>GS</sub> =0 to 10 V	-	15 67	22	
Gate charge total	Q g	<u> </u>	-	67	87	-
Gate plateau voltage	$V_{ m plateau}$	1	-	4.9	-	V
Reverse Diode						
Diode continous forward current <sup>2)</sup>	Is	Т <sub>C</sub> =25 °С	-	-	180	A
Diode pulse current <sup>2)</sup>	I <sub>S,pulse</sub>	$T_{\rm C}$ =25 °C, $t_{\rm p}$ = 100 $\mu$ s	-	-	546	
Diode forward voltage	V <sub>SD</sub>	V <sub>GS</sub> =0 V, I <sub>F</sub> =90 A, T <sub>j</sub> =25 °C	-	0.9	1.2	V
Reverse recovery time <sup>2)</sup>	t <sub>rr</sub>	V <sub>R</sub> =40 V, I <sub>F</sub> =50A,	-	59	-	ns
Reverse recovery charge <sup>2)</sup>	Q rr	d <i>i</i> <sub>F</sub> /d <i>t</i> =100 A/μs	-	85	-	nC

<sup>1)</sup> Practically the current is limited by the overall system design including the customer-specific PCB.

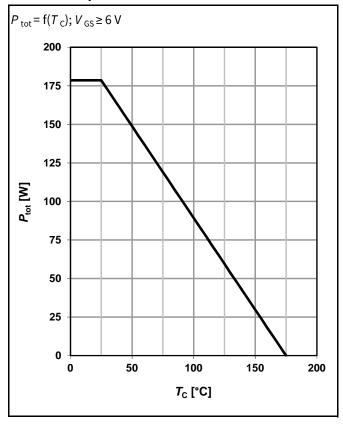
 $<sup>^{2)}\,\</sup>mbox{The parameter}$  is not subject to production testing – specified by design.

<sup>&</sup>lt;sup>3)</sup> Device on 2s2p FR4 PCB defined in accordance with JEDEC standards (JESD51-5, -7). PCB is vertical in still air.

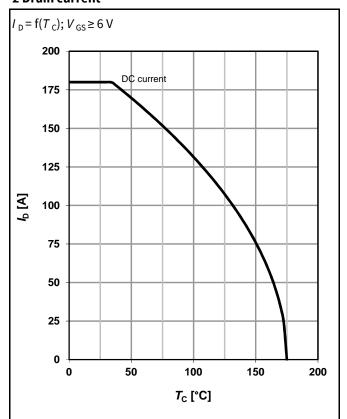


# **Electrical characteristics diagrams**

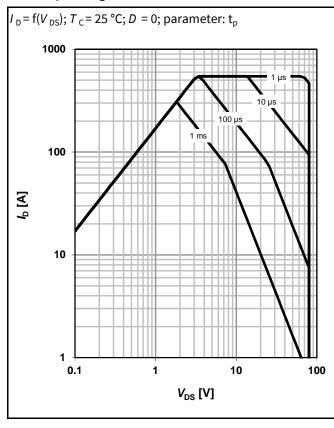
#### 1 Power dissipation



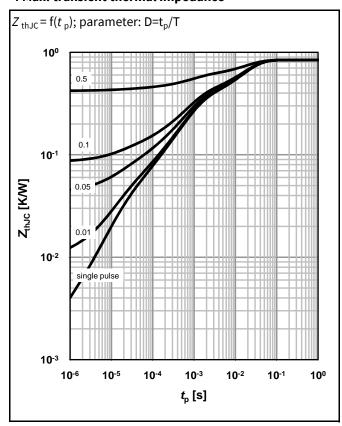
### 2 Drain current



## 3 Safe operating area

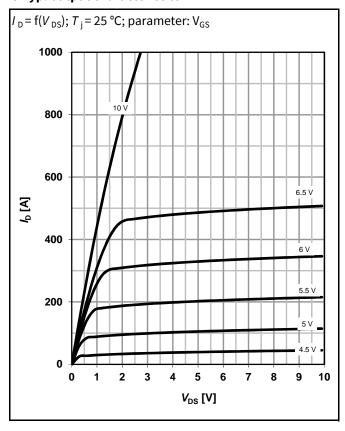


# 4 Max. transient thermal impedance

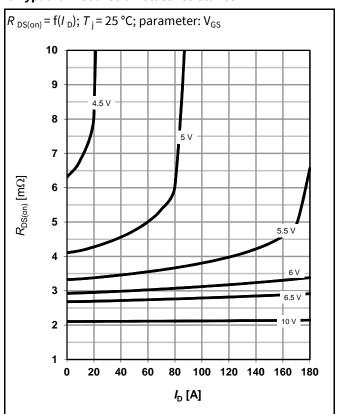




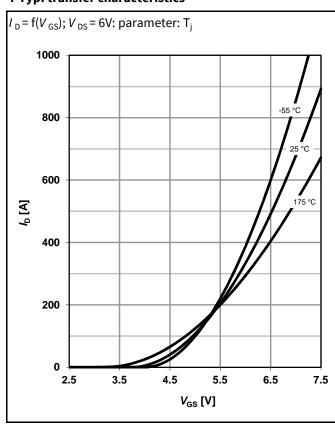
# 5 Typ. output characteristics



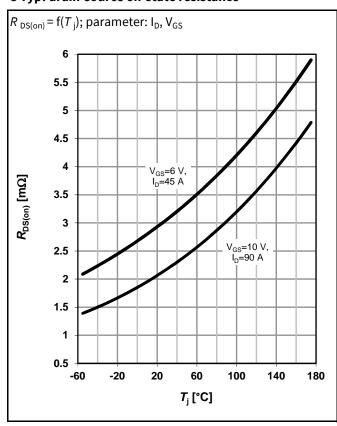
#### 6 Typ. drain-source on-state resistance



# 7 Typ. transfer characteristics

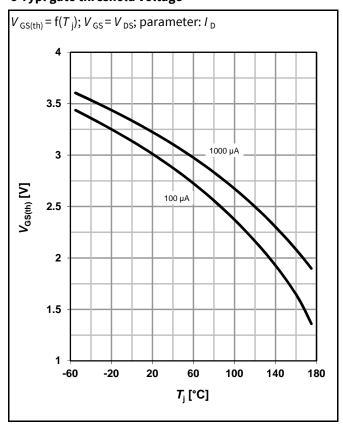


# 8 Typ. drain-source on-state resistance

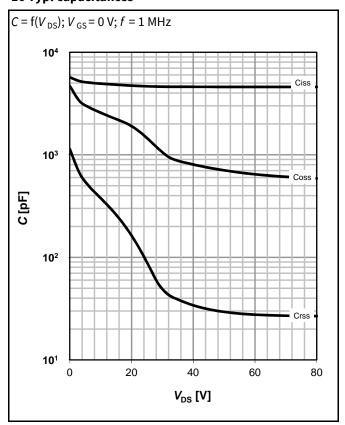


# infineon

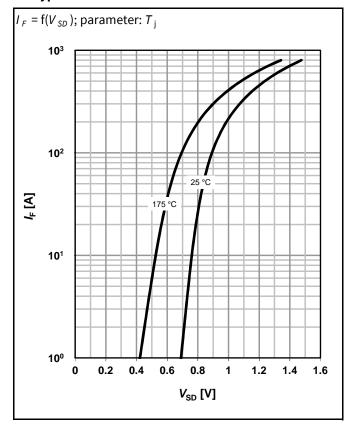
# 9 Typ. gate threshold voltage



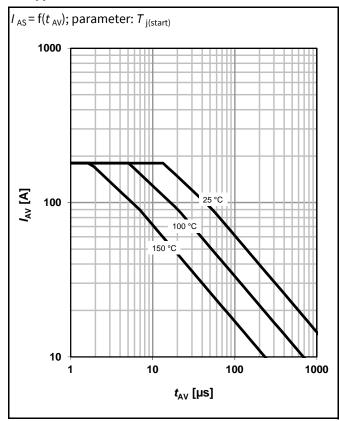
# 10 Typ. capacitances



# 11 Typical forward diode characteristics



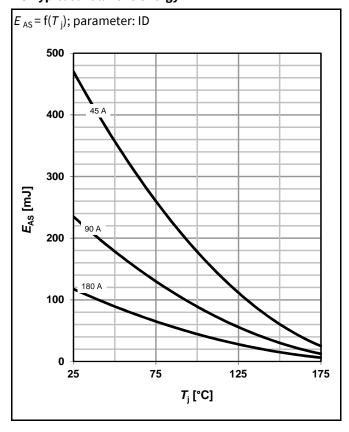
# 12 Typ. avalanche characteristics



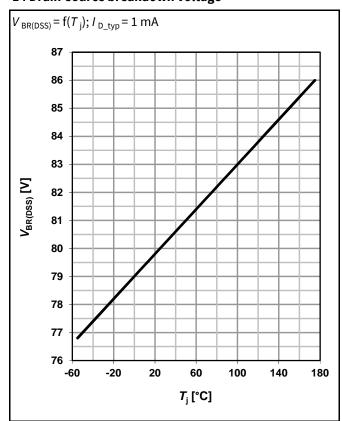
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# infineon

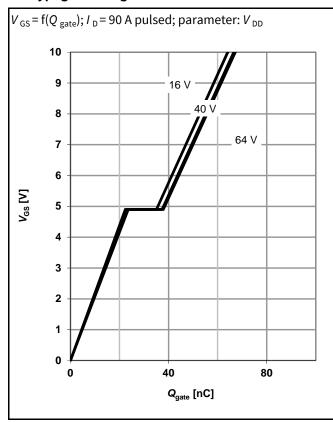
# 13 Typical avalanche energy



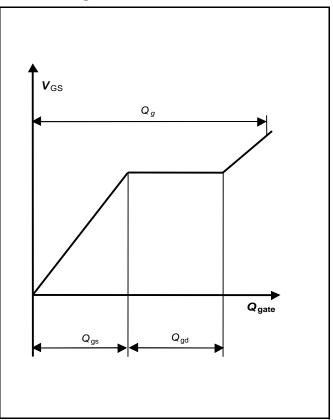
# 14 Drain-source breakdown voltage



# 15 Typ. gate charge



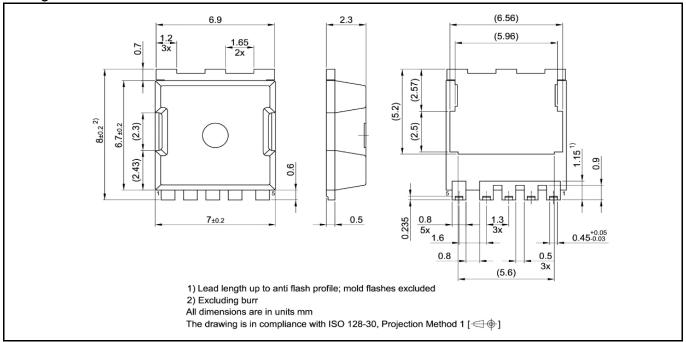
# 16 Gate charge waveforms



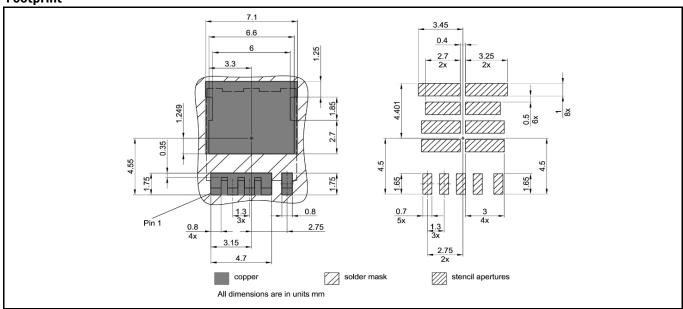
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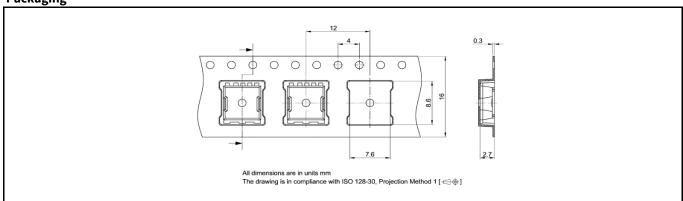
**Package Outline** 



**Footprint** 



**Packaging** 



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# **Revision History**

Revision	Date	Changes
Revision 1.0	16.03.2021	Final Datasheet

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